

Features

- Peak breakdown voltage:
250V: BLM301X; 400V: BLM302X; 600V: BLM305X
- High isolation voltage between input and output (Viso =3750V rms)
- Operating Temperature: -55°C~110°C

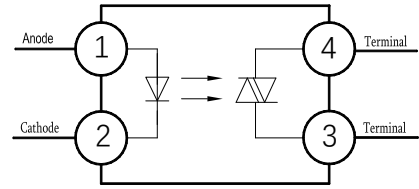
HF

Applications

- Electromagnetic valve controls
- Ballasts
- Static AC power switch
- Interfacing microprocessors to 115 to 240Vac peripherals.
- Incandescent lamp dimmer
- Temperature controls
- Motor controls

Mechanical Data

- Case: SOP4
- Molding Compound: UL Flammability Classification Rating 94V-0
- Terminals: Matte tin-plated leads; solderability-per MIL-STD-202, Method 208



Ordering Information

BL M30VX (M) (G) - (U) (N) (Y)

① ② ③ ④ ⑤ ⑥ ⑦

- ① Brand(BL)
- ② Product series(V:1,2,5;X:0,1,2,3)
- ③ Package type(SOP4:None)
- ④ Halogen option(None :Halogen free)
- ⑤ Lead frame (None: Copper)
- ⑥ Customer option 1 (0-9 or A-Z or none)
- ⑦ Customer option 2 (0-9 or A-Z or none)

Part Number	Package	Shipping Quantity	Marking Code
BLM30V*1X*2	SOP4	3000 pcs / Tape & Reel	BLM30V*1X*2

Notes 1: V denotes V_{DRM} digits: 1, 2, 5.
2: X denotes I_{FT} digits:0, 1, 2, 3.

Marking Information

- "BL" denotes brand
- "V" denotes V_{DRM} digits: 1, 2, 5
- "X" denotes I_{FT} digits: 0, 1, 2, 3
- "Y" denotes Year : A(2024), B(2025), C(2026)
- "WW" denotes Week's number
- "N" denotes the day of Week



Maximum Ratings (@ TA = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit
Input	Forward Current	I _F	60	mA
	Reverse Voltage	V _R	6	V
	Power Dissipation	P _D	100	mW
	Derating factor (above Ta = 85 °C)		3.8	mW/°C
Output	Power Dissipation	P _C	300	mW
	Derating factor (above Ta = 85 °C)		7.4	mW/°C
	Off-state Output Terminal Voltage	V _{DRM}	250	V
			400	
			600	
	Peak repetitive surge current (pw=100μs,120pps)	I _{TSM}	1	A
	Turn-on current (root mean square value)	I _{T(RMS)}	100	mA

Thermal Characteristics

Parameter	Symbol	Value	Unit
Total Power Dissipation	P_{TOT}	330	mW
Isolation Voltage *1	V_{ISO}	3750	Vrms
Operating Temperature	T_{OPR}	-55 ~ +110	°C
Storage Temperature Range	T_{STG}	-55 ~ +125	°C
Soldering Temperature *2	T_{SOL}	260	°C

Notes:

1. 40 to 60% RH, AC for 1 minute. At this time, pins 1, 2 & 3 are shorted, and pins 4, 5 & 6 are shorted together.

2. For 10 seconds

Electrical Characteristics (@ $T_A = 25^{\circ}\text{C}$ unless otherwise specified)

Parameter		Symbol	Test Condition	Min.	Typ.	Max.	Unit
Input	Forward Voltage	V_F	$I_F=20\text{mA}$	-	1.23	1.5	V
	Reverse Leakage current	I_R	$V_R=6\text{V}$	-	-	10	μA
Output	Peak Blocking Current	I_{DRM}	$V_{DRM}=\text{Rated } V_{DRM}, I_F=0\text{mA}$	-	-	100	nA
	Peak on-state voltage	V_{TM}	$I_{TM}=100\text{mA}, I_F=\text{Rated } I_{FT}$	-	-	2.5	V
	Critical Rate of Rise off-state Voltage	BLM301X	$V_{PEAK}=\text{Rated } V_{DRM}, I_F=0\text{mA}$	-	100	-	$\text{V}/\mu\text{s}$
		BLM302X		-	-	-	
Transfer Characteristics	LED trigger current	BLM305X	$V_{PEAK}=400\text{V}, I_F=0$	1000	-	-	mA
		BLM3010	Main terminal voltage = 3V	-	-	30	
		BLM3020		-	-	15	
		BLM3011		-	-	10	
		BLM3021		-	-	5	
		BLM3051		-	-	5	
		BLM3012		-	-	5	
		BLM3022		-	-	5	
		BLM3052		-	-	5	
		BLM3013		-	-	5	
		BLM3023		-	-	5	
		BLM3053		-	-	5	
	Holding Current	I_H		-	250		μA

Ratings and Characteristics Curves (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Fig.1 LED Positive voltage vs Positive current

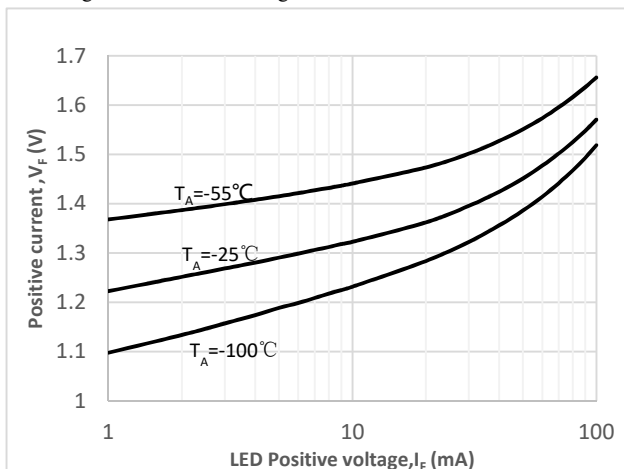


Fig.2 On-state characteristic

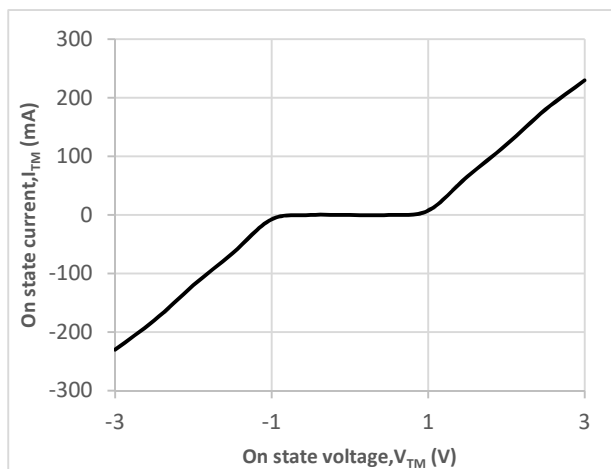


Fig.3 Trigger current vs Ambient temperature

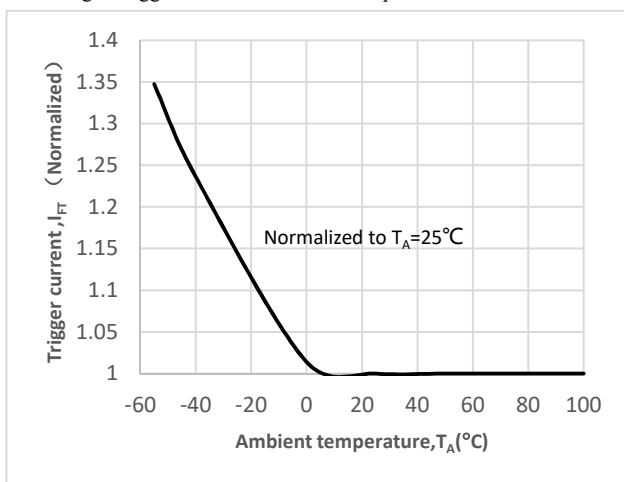


Fig.4 LED Trigger current vs LED Pulse Width

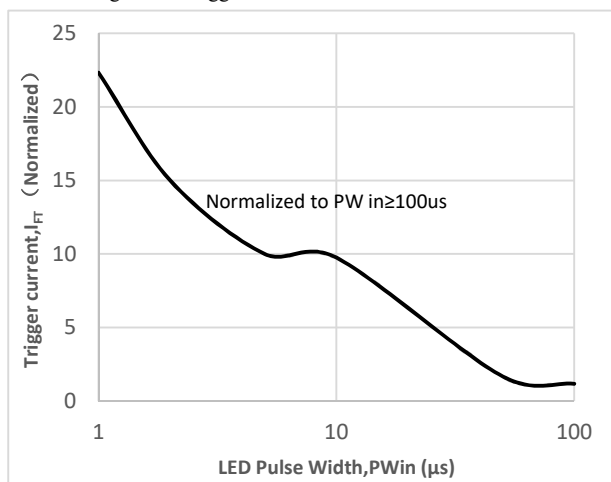


Fig.5 Holding current vs Temperature

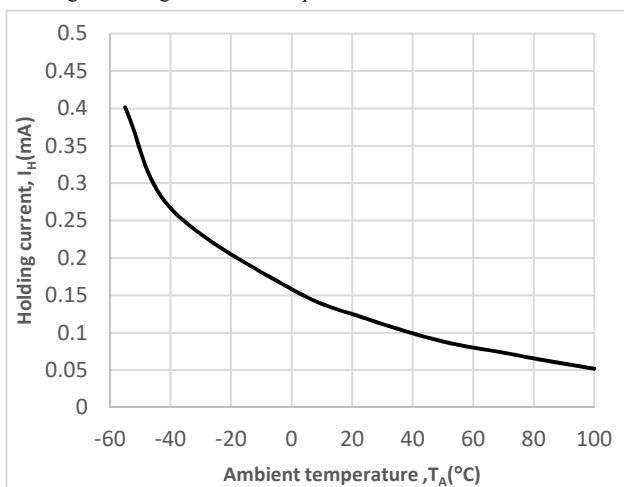


Fig.6 Leakage current vs Temperature

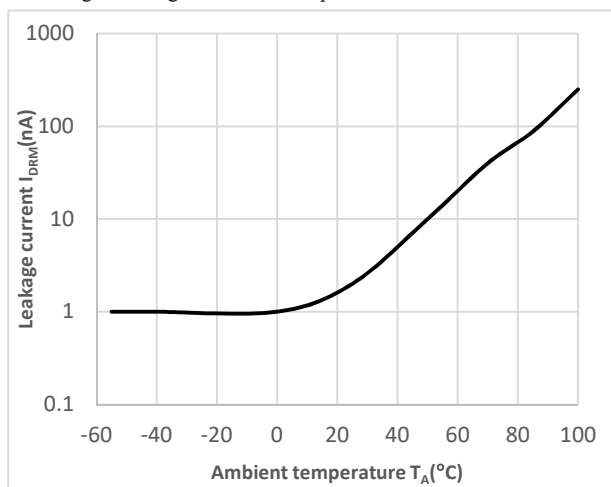
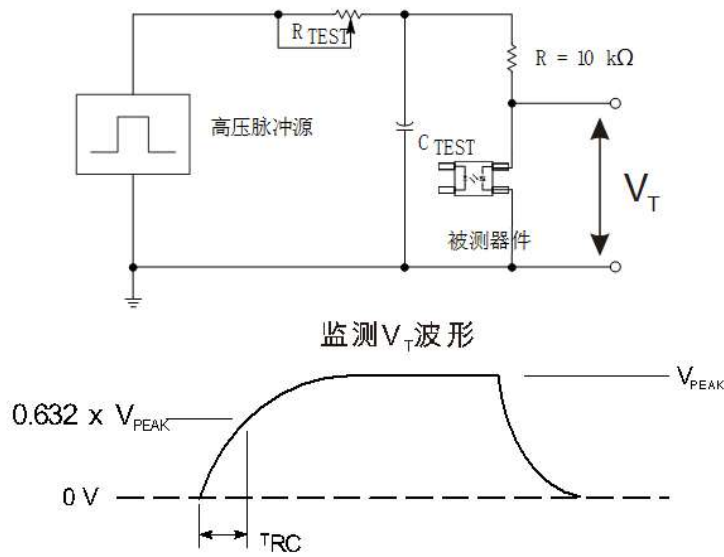


Fig.7 Static dv / dt test circuit and waveform



The high voltage pulse applied to the output of the device under test through the RC circuit is set to the required V_{PEAK} value. LED current is not applied. The waveform V_T is monitored with X100 probe. By adjusting the R_{TEST} value, the dv/dt (slope) increases until the device under test is observed to be triggered (waveform collapse). Then dv/dt drops until the device under test stops being triggered. At this point, τ_{RC} is recorded and the dv/dt calculated.

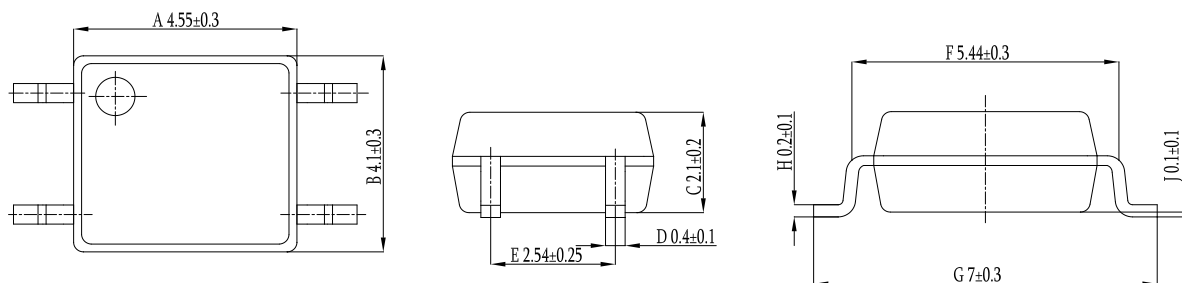
$$dv/dt = \frac{0.632 \times V_{PEAK}}{\tau_{RC}}$$

For example, $V_{PEAK} = 400V$ for BLM302X series. The dv/dt value is calculated as follows:

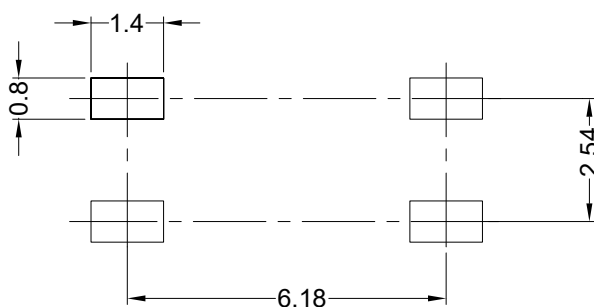
$$dv/dt = \frac{0.632 \times 400}{\tau_{RC}} = \frac{252}{\tau_{RC}}$$

Package Outline Dimensions (unit: mm)

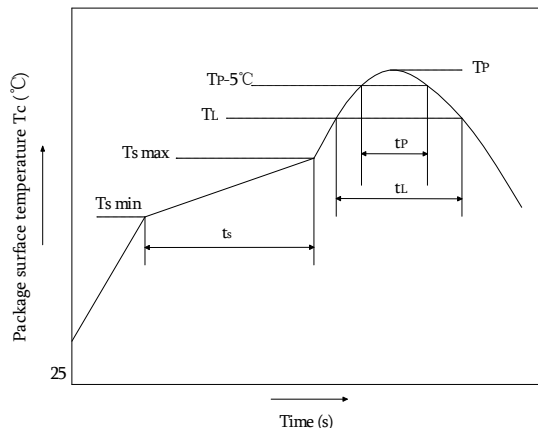
SOP4



SOLDERING FOOTPRINT (unit: mm)



Reflow soldering

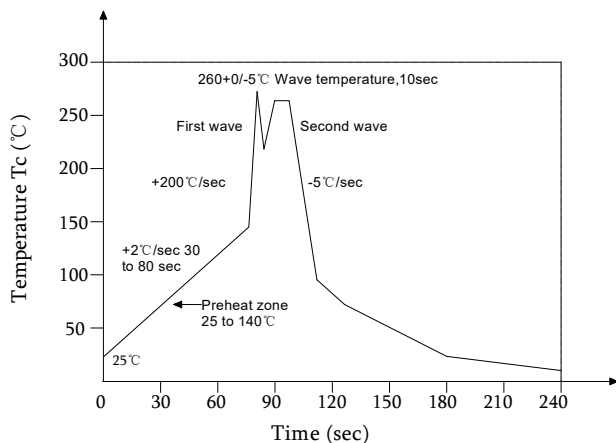


	Symbol	Min	Max	Unit
Preheat temperature	Ts	150	200	°C
Preheat time	ts	60	120	s
Ramp-up rate(T _L to T _P)			3	°C/s
Liquidus temperature	T _L	217		°C
Time above T _L	t _L	60	150	s
Peak temperature	T _P		260	°C
Time during which T _c is between (T _P -5) and T _P	t _p		30	s
Ramp-down rate(T _P to T _L)			6	°C/s

Note:

Reflow soldering is recommended at the temperatures and times shown, no more than three times.

Wave soldering



Profile feature	
Average ramp-up rate	~200°C/s
Heating rate during preheat	1°C/s to 2°C/s typical; 4°C/s maximum
Final preheat temperature Ts	~130°C
Preheat time (25°C to Ts)	>60s
Peak temperature T _P	260°C
Time within peak temperature t _p	10s
Ramp-down rate	5°C/s maximum

Soldering with hand soldering iron

- Hand soldering iron is only used for product rework or sample testing.
- Hand soldering iron requirements: Temperature: 360 °C ± 5°C within 3s.

Pcaking

Package Type	Packing Form	Quantity per Tube &Reel	Quantity per Box	Quantity per Carton	Antistatic Bag Specification	Box Specification	Carton Specification	Note
SOP4	Reel($\phi 330$ mm)	3000 pcs/reel	2 reels /box	5 boxes /ctn	380*420mm	350*340*60mm	365*330*370mm	Guard band 200mm /min.

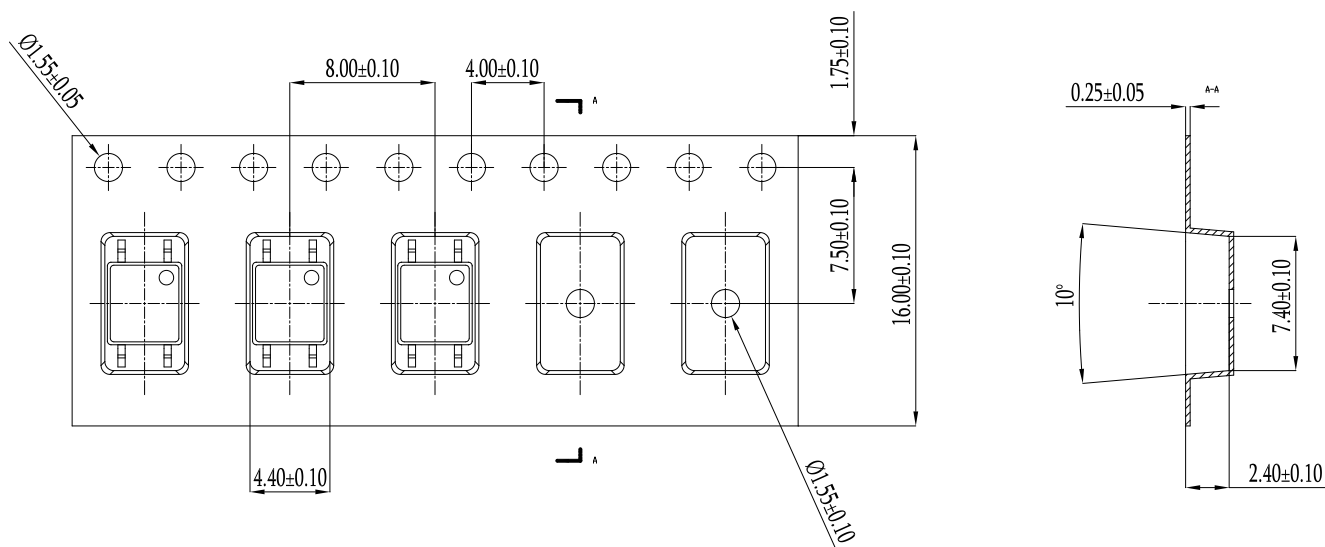
■Summary table

■SOP4 (Reel)

Qty/reel: 3000 pcs. Qty/box: 6000 pcs.

Qty/ctn : 30000 pcs.

Schematic: (unit:mm)



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